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# Investigation of soft X-ray detection with iLGAD sensors

01.03.2023 – 18th Trento Workshop on Advanced Silicon Radiation Detectors

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## Soft X-ray applications at Synchrotrons and FELs (250 eV – 2 keV)

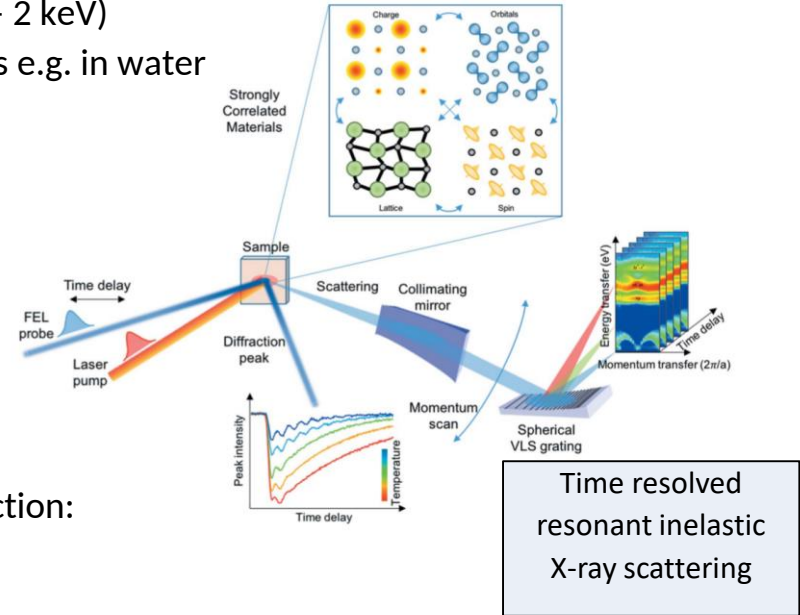
- Access K-edges of biologically relevant elements e.g. in water window 250-520 eV
- L-edges of 3d transition metals, Fe, Cu, etc.

### Possible applications:

- Proteins and Pharmaceutical
- Magnetic domains
- Quantum materials
- Bio-imaging.

### Current limitations of hybrid detectors for soft X-ray detection:

- **Low quantum efficiency (QE);**
- **Electronic noise** → low signal to noise ratio (SNR).

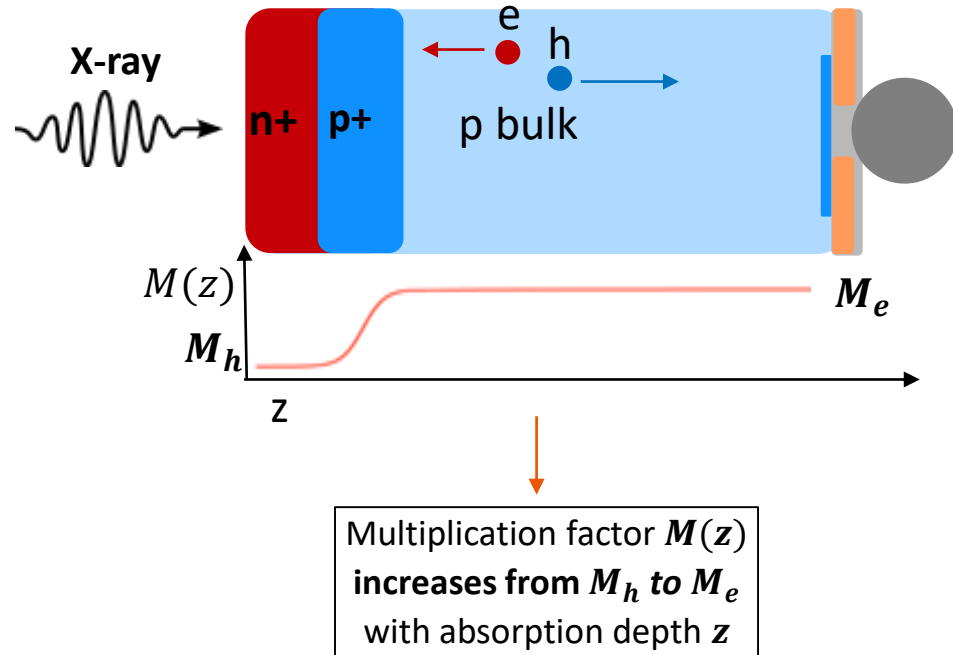


Time resolved  
resonant inelastic  
X-ray scattering

PSI and FBK collaborate for the development of **iLGAD sensors with optimized entrance window** for soft X-Ray detection.

## iLGAD layout:

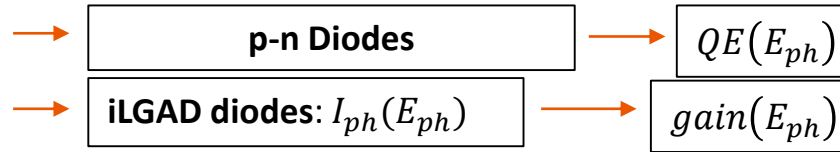
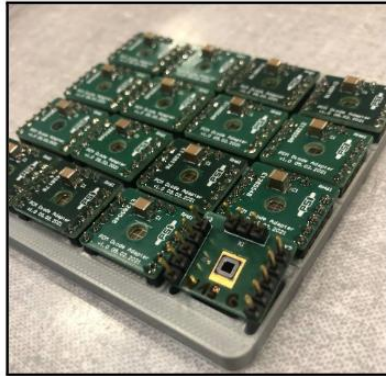
- 100% fill factor;
- Interpolation through charge sharing for high spatial resolution;
- Hole collection;
- Double sided process;
- Needs to be compatible with optimized entrance window;
- Multiplication factor depends on depth where X-rays absorbed.



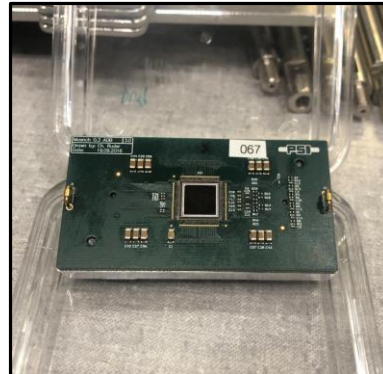
# Test of iLGADs with optimized entrance window

- **8 iLGAD process splits from FBK**
- 275  $\mu\text{m}$  thick with **different entrance window and gain layer (GL) designs**.
- Measurements at Synchrotron (SLS),  $E_{ph} \in [200\text{eV}, 1\text{keV}]$ .

In vacuum  
+20°C  
300V



In vacuum  
-40°C  
300V

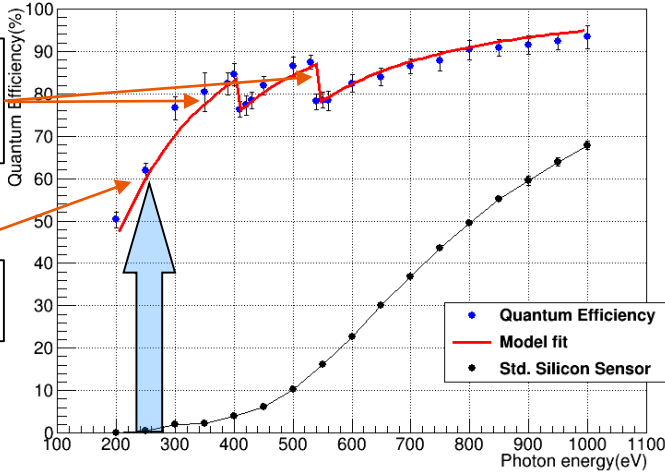


**Pixelated iLGADs  
(25  $\mu\text{m}$  pitch)  
charge integrating  
Mönch readout**

**Spectra**

# p-n diodes: QE vs $E_{ph}$

**QE vs  $E_{ph}$  - UShallow  $n^+$  (W13)**



Absorption  
Edges of  
passivation

$QE(250eV)$   
> 60%

**QE model:**

$$QE(E_{ph}) = e^{\frac{-l_1}{\lambda_1(E_{ph})}} e^{\frac{-l_2}{\lambda_2(E_{ph})}} \int_0^W \frac{e^{\frac{-z}{\lambda_{Si}(E_{ph})}}}{\lambda_{Si}(E_{ph})} CCE(z) dz$$

From ratio at  
edges  $\frac{QE(E_{edge}^+)}{QE(E_{edge}^-)}$

$$l_1 + l_2 \sim 85nm$$

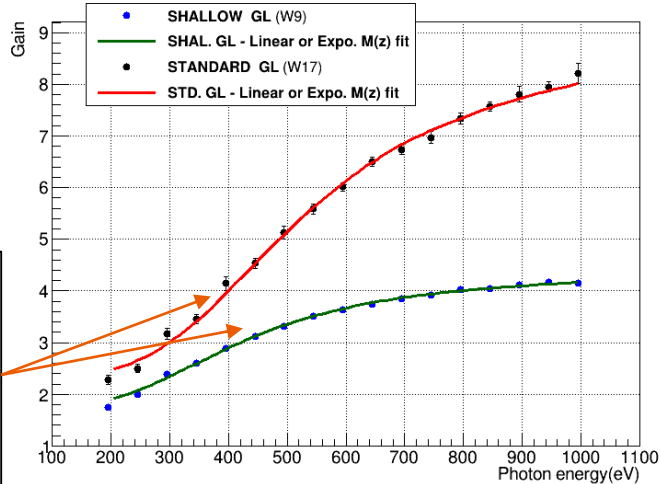
From fit of  $l_1, l_2, l_d$  with  
dead layer CCE:

$$CCE(z) = \begin{cases} 0 & \text{if } z \leq l_d \\ 1 & \text{if } z > l_d \end{cases}$$

$$l_d < 1nm$$

**High CCE: Almost  
complete charge  
collection**

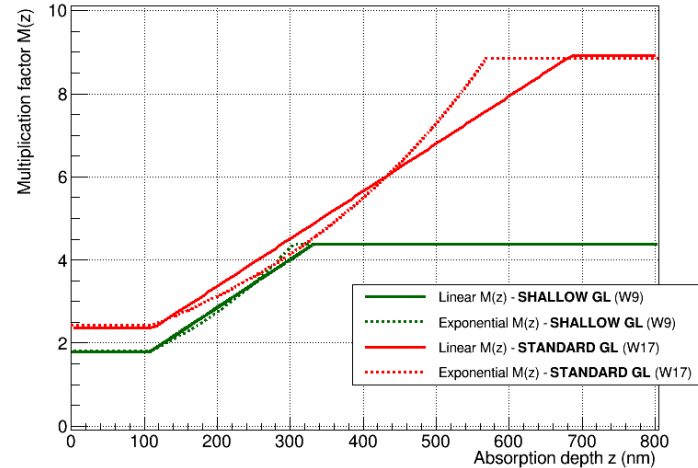
**Average gain vs  $E_{ph}$**



Measured at +20°C

Linear and expon. fit: overlapping best fit function

**M(z)**

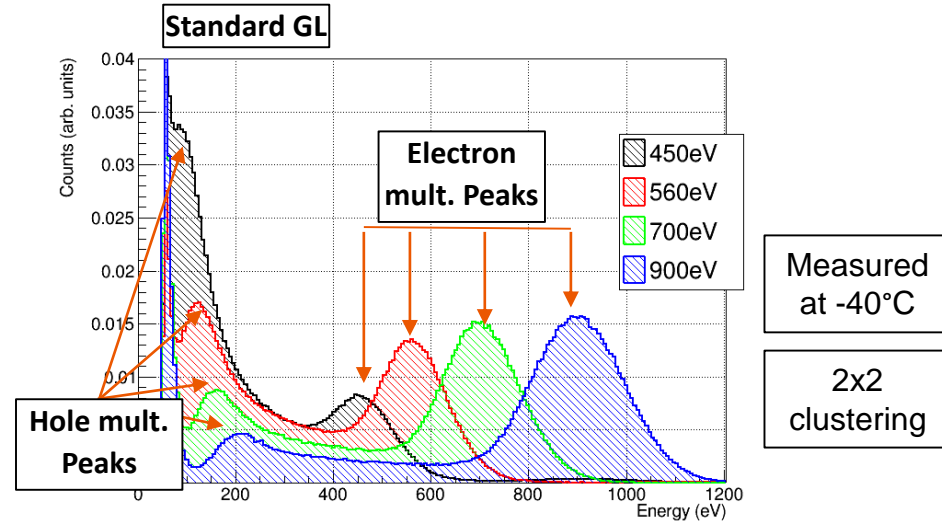
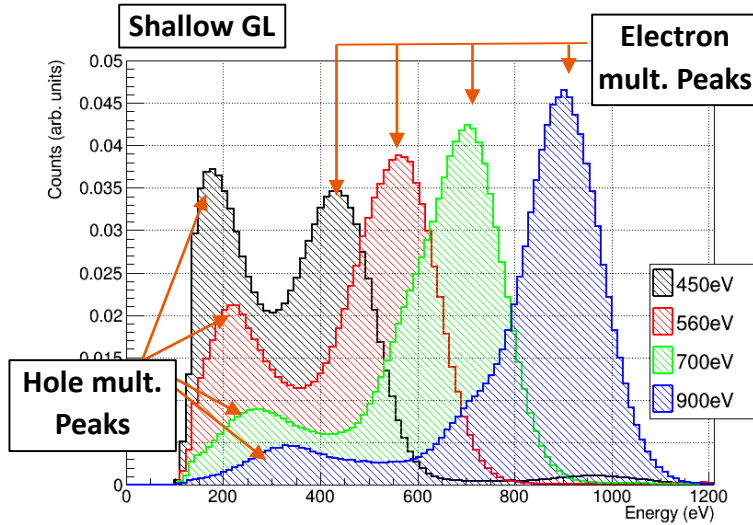


**Gain expression (assuming CCE =1) :**

$$g_{iLGAD}(E_{ph}) \sim \int_0^W \frac{e^{-z/\lambda_{Si}(E_{ph})}}{\lambda_{Si}(E_{ph})} M(z) dz$$



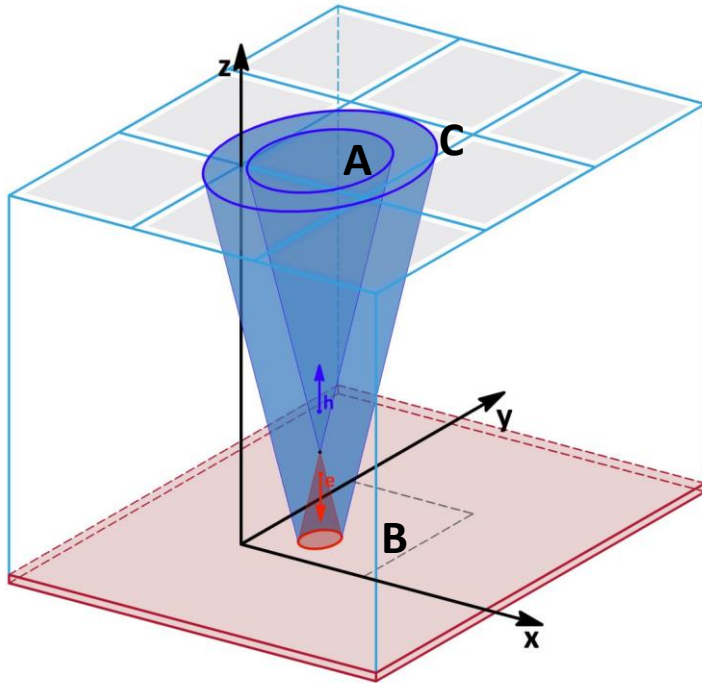
**M(z) is extracted from the gain fit.**  
**Linear and exponential models used with fit parameters  $M_e, M_h, t_2$**   
 $t_1$  is fixed from process simulation



Double peaks feature due to electron and hole multiplication observed for mono-energetic soft X-rays:

- Both peaks visible down to 450eV.
- Ratio of the area under peaks changes with  $E_{ph}$ .
- The ratio  $M_h/M_e$  is larger for shallow GL

} → Depending on the gain layer design

**Simulation inputs:**

- 1) Doping profiles from process simulation → E-field
- 2)  $M(z)$  - from gain fit + Okuto scaling of  $M_h$  and  $M_e$
- 3) Detector electronic noise  $\sigma_0$  - Measured

**Monte Carlo Simulation:**

- 1) Carriers generation by X-Ray absorption
- 2) Multiplication
- 3) Drift and diffusion of carriers clouds (A,B,C)

**Clustering and noise:**

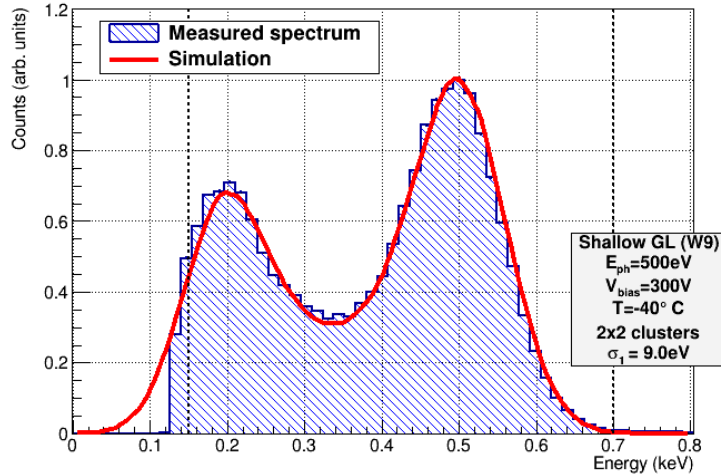
- 1) 2x2 pixel clusters considered
- 2) Noise: gaussian fluctuations of the cluster

$$\text{charge with } \sigma_{noise} = 2\sqrt{\sigma_0^2 + \sigma_1^2 M(z)^2 F(z)}$$

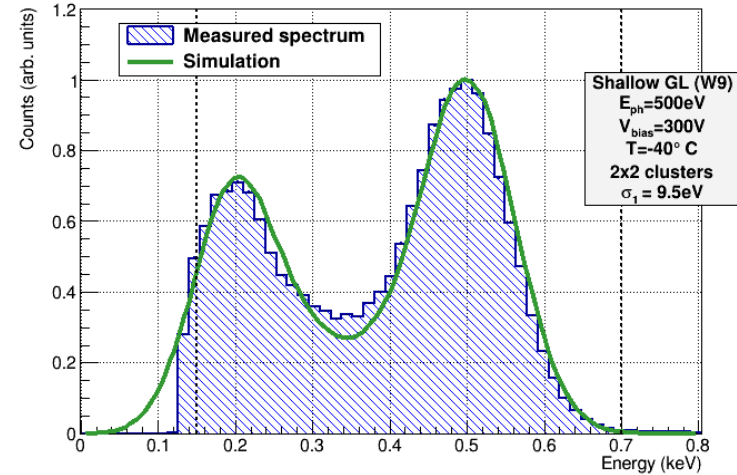


# Comparison simulated/measured spectrum

Shallow GL – Linear  $M(z)$  sim. -  $E_{ph} = 500eV$



Shallow GL – Expon.  $M(z)$  sim. -  $E_{ph} = 500eV$



## Observations:

- 1) Double peak feature reproduced in the simulation;
- 2) Okuto model provides correct scaling of ratio  $M_h/M_e$  for T change  $+20^{\circ}C \rightarrow -40^{\circ}C$ .
- 3) The shape of the valley sensitive to transition of  $M(z)$  from  $M_h$  to  $M_e$ .

**Linear  $M(z)$  gives better description** of the measured spectrum.

## Conclusions:

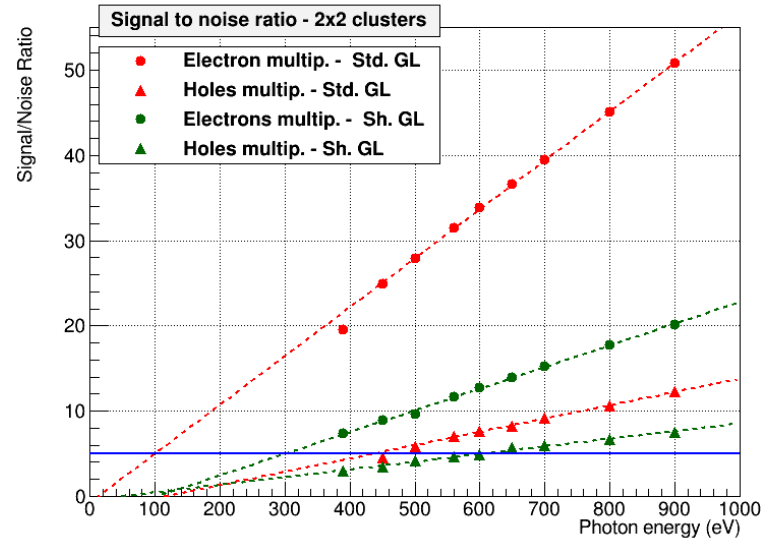
- 1) **QE** of tested wafers  $> 60\%$  for photon energies  $> 250\text{eV}$
- 2) High CCE and low noise enable the detection of **“hole-multiplication peak”** in the spectra down to **450eV**
- 3) **Simulations reproduce the double peak** feature of the spectrum

## Next steps:

- 1) Simulation of the spectrum at other photon energies
- 2) Implementation of the simulation for different process splits
- 3) Studies of impact ionization in different E-field and temperature are needed for reliable predictions of iLGAD spectra with device simulation

# Outlook for future developments

- 1) Further reduction of passivation thicknesses would improve QE
- 2) 2x gain increase in shallow design is needed to observe 400eV photons with  $SNR > 5$  for both holes and electron multiplication peaks;
- 3) Shallower gain layer would enhance probability of electron-initiated multiplication.



# Acknowledgment



FONDAZIONE  
BRUNO KESSLER

Matteo Centis Vignali  
Francesco Ficorella  
Giacomo Borghi  
Giovanni Paternoster  
Maurizio Boscardin  
Sabina Ronchin  
Omar Hammad Ali

## The Photon Science Detector Group at PSI

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Middle: Erik Frojdh, Carlos Lopez, Martin Bruckner, Christian P. Ruder, Bernd Schmitt, Konstantinos Moustakas, Dominic Greiffenberg. Front: Viktoria Hinger, Dhanya Thattil, Roberto Dinapoli, Shqipe Hasanaj, Maria Carulla, Simon Ebner. Missing: Rebecca Barten, Pawel Kozlowski, Filippo Baruffaldi, Xiangyu Xie, Kirsty Anne Paton.

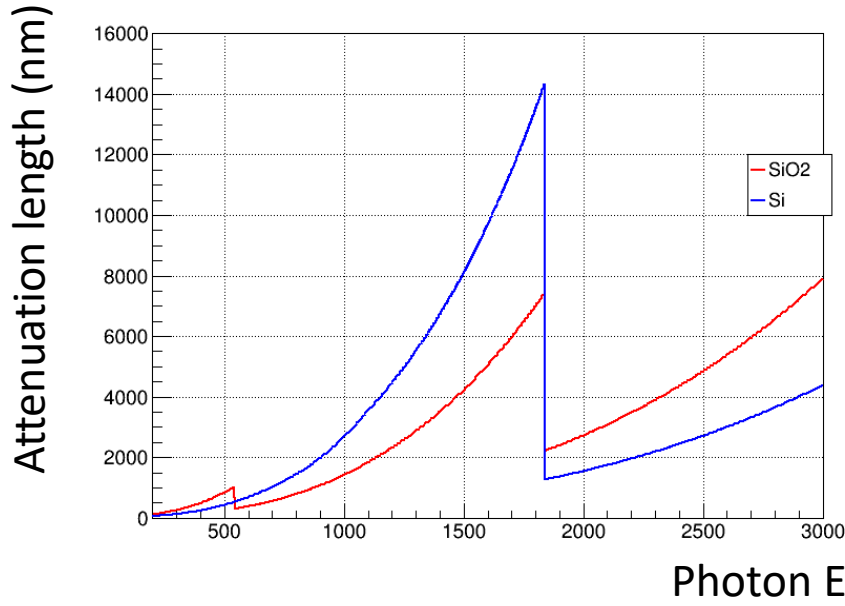




# Backup slides



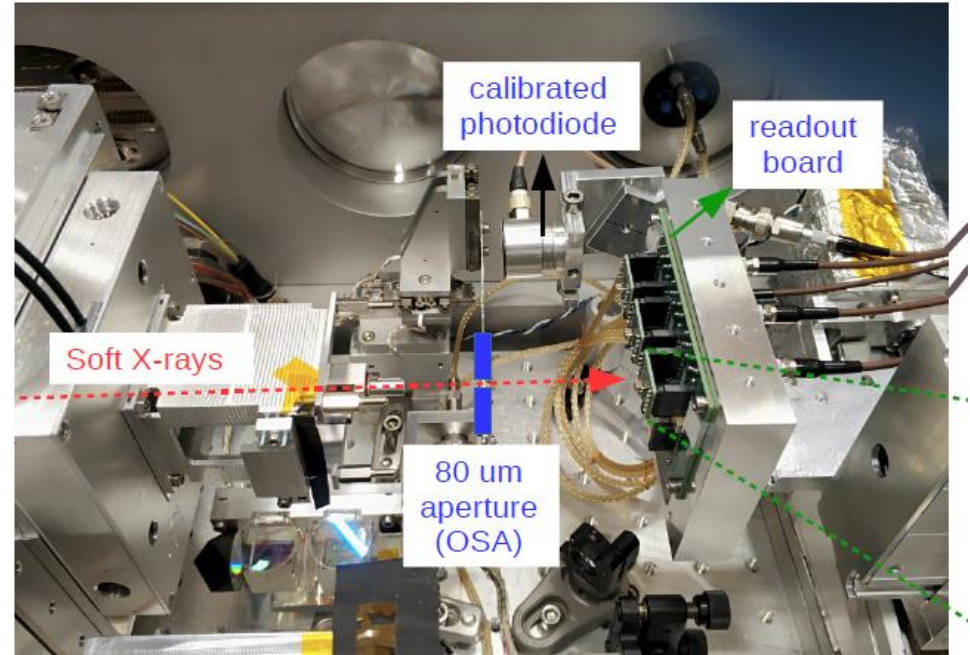
# Attenuation length for soft X-rays



Photon energy (eV)	Att. Length in Si (microns)
251.200	9.37E-02
500.800	0.432091
800.000	1.43566

# Diodes measurement setup

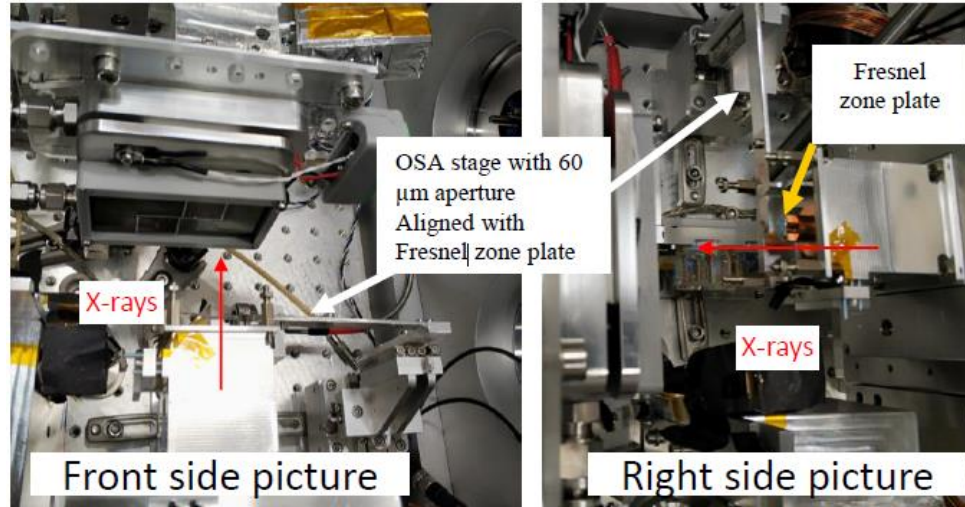
- Surface Interfaces Microscopy (SIM) beamline at SLS
- 3 DUT are connected to the readout board, and biased at 300V.
- The readout board is mounted on a stage together with a calibrated photodiode.
- At each energy the dark current and the current under illumination are measured for all devices.
- Temperature stabilized at +20°C with a chiller (not shown)



\*Courtesy of M. Carulla

# Pixelated iLGAD setup

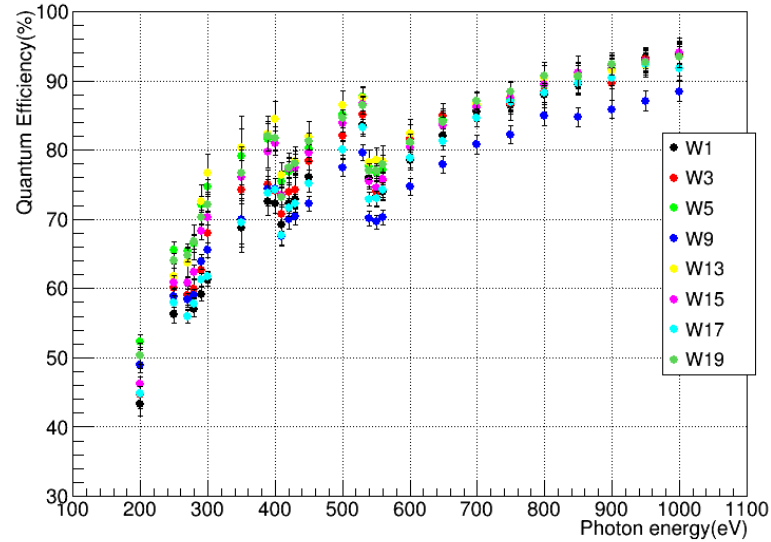
- Illumination with a Fresnel zone plate + OSA
- Peltier system to cool the sensor to  $-40^{\circ}\text{C}$



\*Courtesy of M. Carulla



# QE vs $E_{ph}$ for all process splits

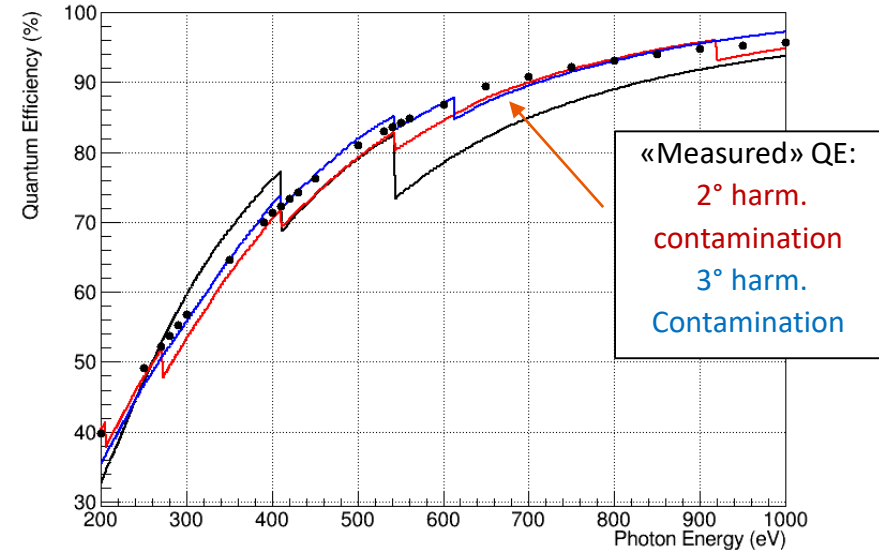


$$QE = \frac{I_{ph}}{I_{ph c}} QE_c$$

# Higher harmonics contamination

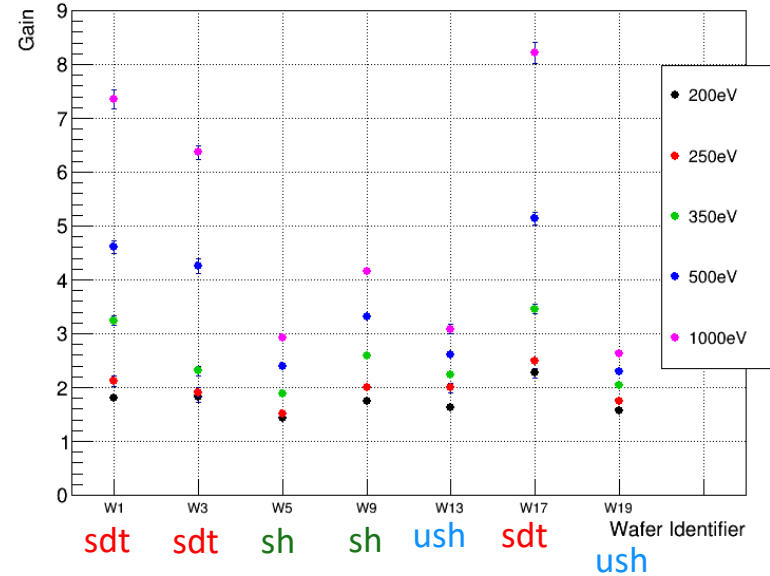
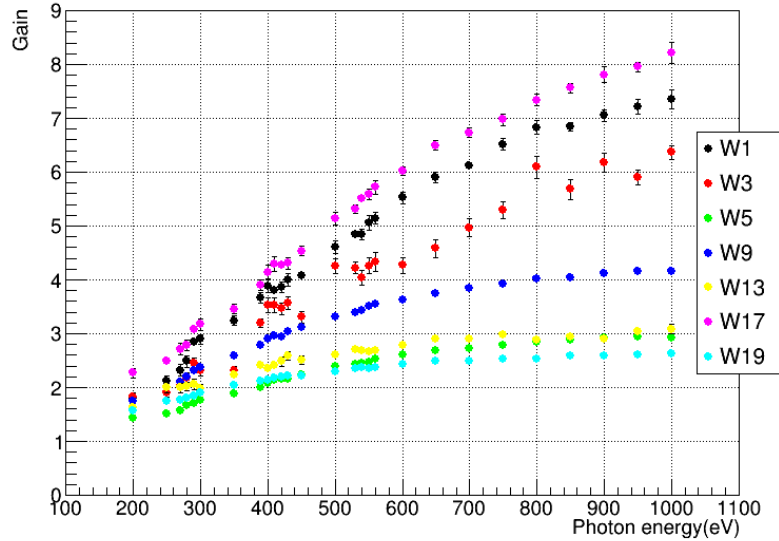
$$\eta_{measured}(E_{ph}) = \frac{I_L(E_{ph}) + I_H(E_{ph})}{I_{Lc}(E_{ph}) + I_{Hc}(E_{ph})} \eta_c(E_{ph})$$

$$\eta_{measured}(E_{ph}) = \frac{\eta_L \eta_{Lc}}{\eta_{Lc} + n \left( \frac{\Phi_H}{\Phi_L} \right) \eta_{Hc}} + \frac{\eta_H \eta_{Lc}}{\eta_{Hc} + \frac{1}{n} \left( \frac{\Phi_L}{\Phi_H} \right) \eta_{Lc}}$$



Higher harmonic contamination determines an **underestimation of QE( $E_{ph}$ )** if the calibrated photodiode has a quantum efficiency  $QE_0(E_{ph}) < QE(E_{ph})$ . This is the case **at low  $E_{ph}$** .

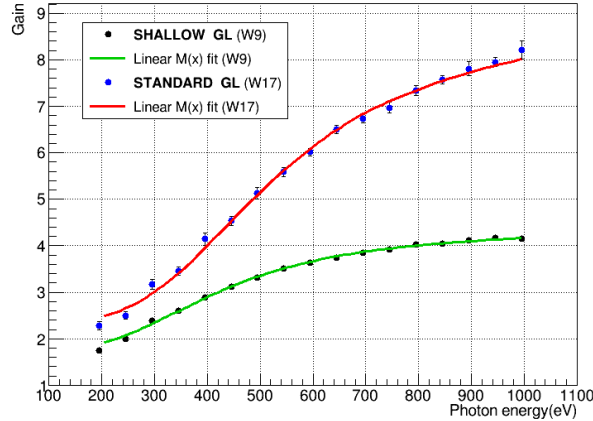
# Gain vs $E_{ph}$ for all process splits



$$G_{iAaLGAD} = \frac{I_{ph} i_{LGAD}}{I_{ph} c1} \bigg/ \frac{I_{ph} pin}{I_{ph} c2}$$

# iLGAD diodes: gain vs $E_{ph}$ & linear model for $M(z)$

Gain vs  $E_{ph}$  - iLGADs with standard GL (W17) and shallow GL (W9)



Gain expression (assuming CCE =1) :

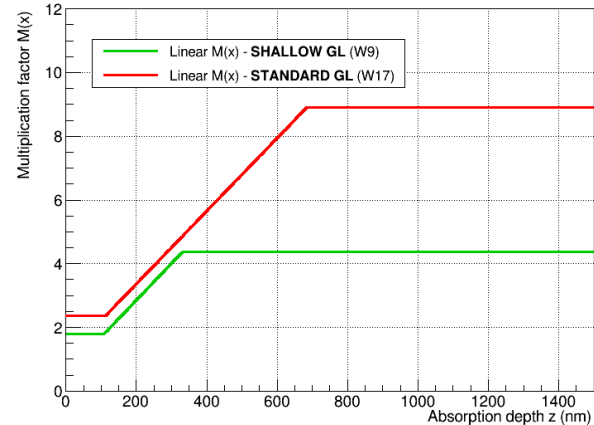
$$g_{iLGAD}(E_{ph}) \sim \int_0^W \mu(E_{ph}) e^{-\mu(E_{ph}) \cdot z} \cdot M(z) dz$$

With linear model  $M(z)$  in GL

$$M(z) = \begin{cases} M_h & \text{if } z \leq t_1 \\ \text{linear} & \text{if } t_1 \leq z \leq t_2 \\ M_e & \text{if } t_2 \leq z \end{cases}$$

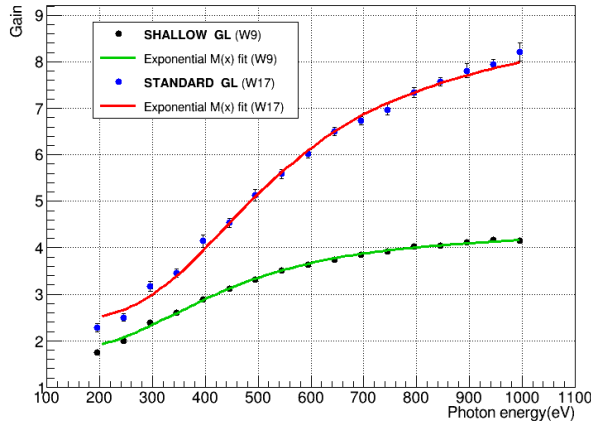
From fit of Linear  $M(z)$  model:

Standard GL:	Shallow GL:
$M_e = 8.9 \pm 0.1$	$M_e = 4.4 \pm 0.02$
$M_h = 2.3 \pm 0.1$	$M_h = 1.78 \pm 0.05$
$t_1 = 112\text{nm}$ (fixed)	$t_1 = 107\text{nm}$ (fixed)
$t_2 = 690\text{nm} \pm 40\text{nm}$	$t_2 = 330\text{nm} \pm 40\text{nm}$



# iLGAD diodes: gain vs $E_{ph}$ & exponential model for $M(z)$

Gain vs  $E_{ph}$  - iLGADs with standard GL (W17) and shallow GL (W9)



From fit of exponential  $M(z)$  model:



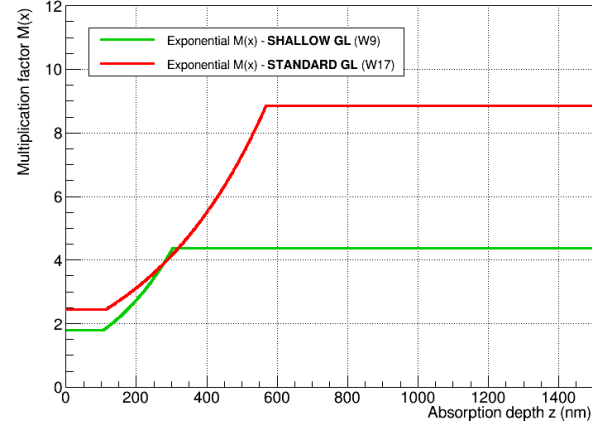
Standard GL:	Shallow GL:
$M_e = 8.8 \pm 0.1$	$M_e = 4.4 \pm 0.02$
$M_h = 2.44 \pm 0.08$	$M_h = 1.80 \pm 0.06$
$t_1 = 112nm$ (fixed)	$t_1 = 107nm$ (fixed)
$t_2 = 570nm \pm 30nm$	$t_2 = 303nm \pm 20nm$

Gain expression (assuming CCE =1) :

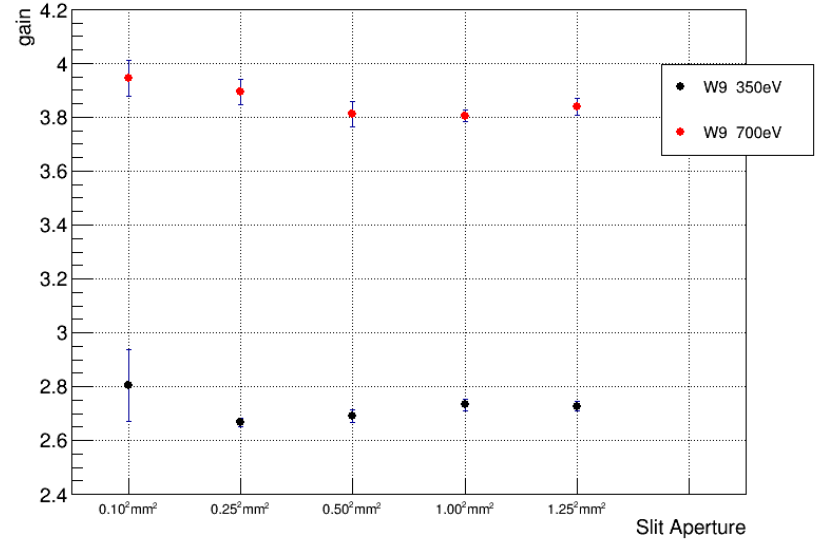
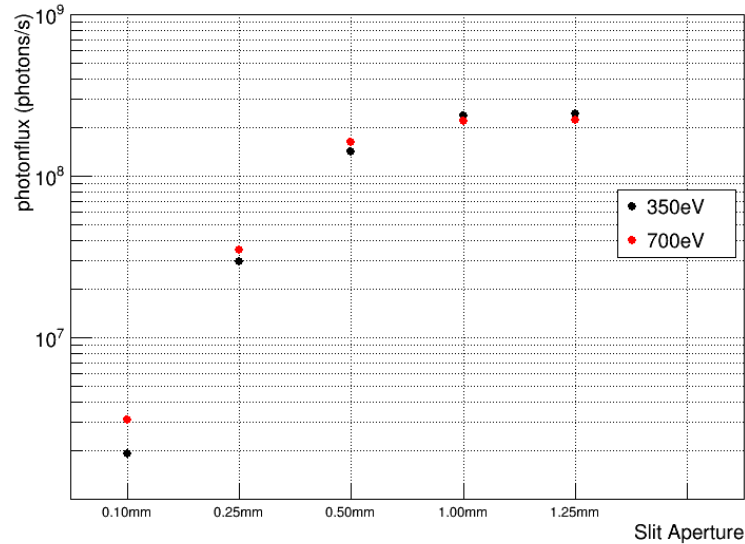
$$g_{iLGAD}(E_{ph}) \sim \int_0^W \mu(E_{ph}) e^{-\mu(E_{ph}) \cdot z} \cdot M(z) dz$$

With exponential model  $M(z)$  in GL

$$M(z) = \begin{cases} M_h & \text{if } z \leq t_1 \\ \text{exponential} & t_1 \leq z \leq t_2 \\ M_e & \text{if } t_2 \leq z \end{cases}$$



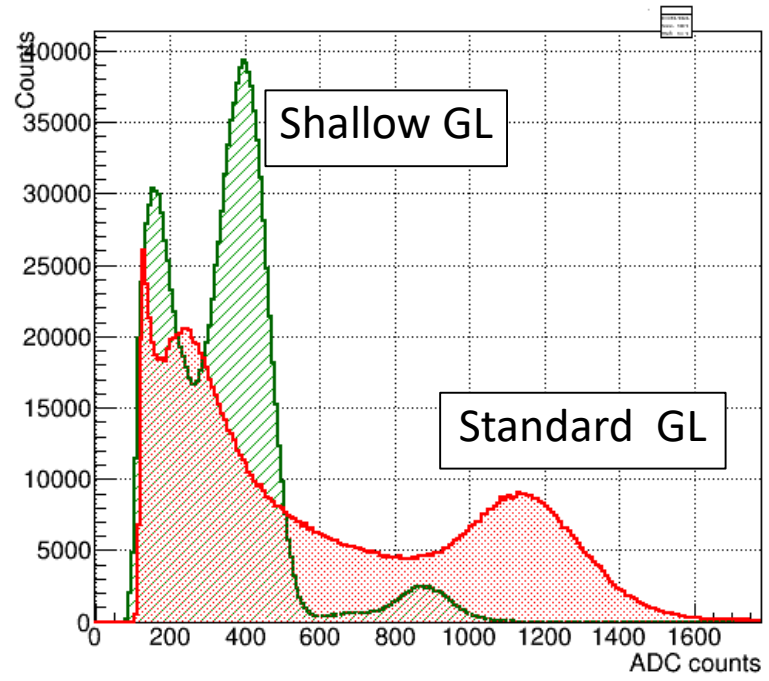
# Gain vs beam intensity at 350eV and 700eV



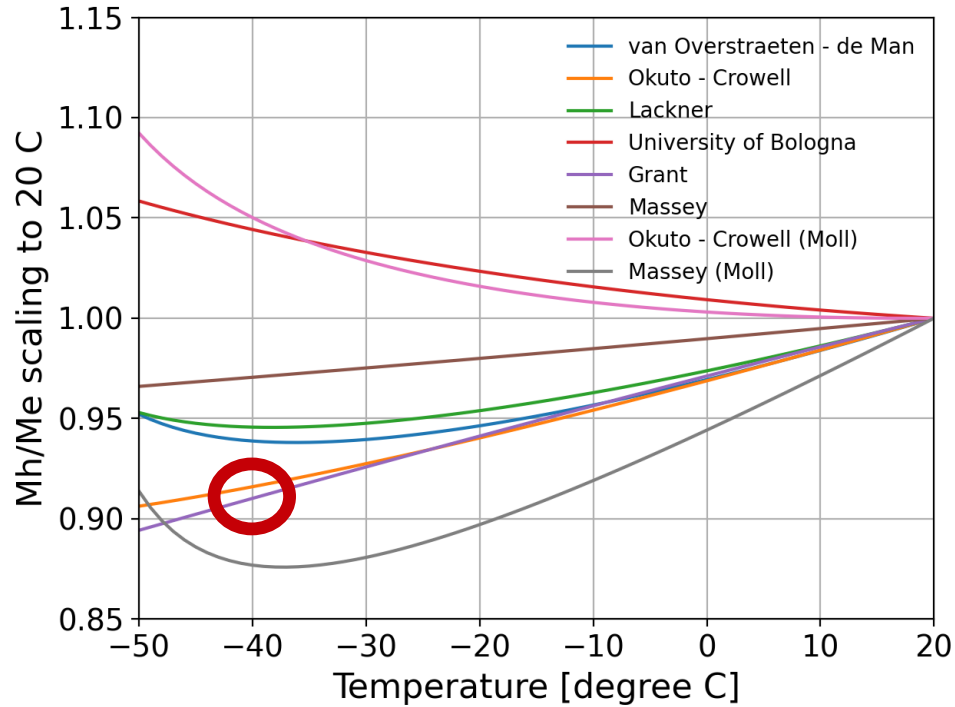
$$\frac{dN_{ph}}{dt} = \frac{I_{ph} * 3.6eV}{e * QE * E_{ph}}$$

# Un-calibrated spectra

$$E_{ph} = 500eV$$



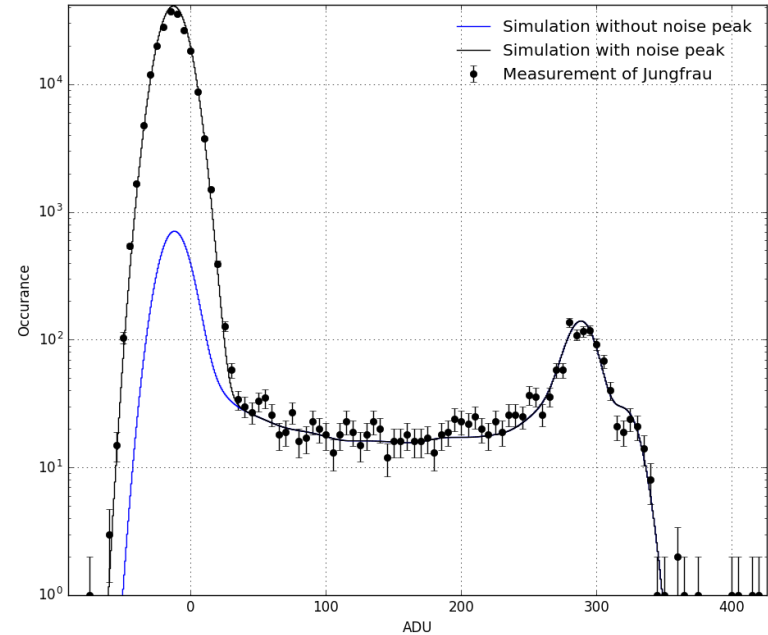
# Scaling of the ratio Mh/Me for temperature change wrt +20°C: different models comparison





# Validation of the mobility model for simulation

- The model is a combination of :
  - Arora model (for the description of the doping dependence)
  - Jacoboni and Selberherr models (for the T dependence)
  - Extended Canali model (for the E-field dependence)



# Chi2 minimization wrt shot noise scaling parameter $\sigma_1$

